

IEEE 802.3 Ethernet Working Group

Membership list

as of 07 April 2022

(204)

Scope of the Working Group

The IEEE 802.3 Working Group is chartered to maintain and revise the Ethernet standard, develop new Ethernet standards in a reasonable time frame, forward these standards to ISO/IEC JTC1 SC6, and maintain liaisons with other groups within the IEEE 802 LAN/MAN Standards Committee and other relevant standards development organizations.

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Vice Chair	Adam Healey
Executive Secretary	Steve Carlson
Secretary	Jon Lewis
Treasurer	Val Maguire

Name	Affiliation
Abbott, John	Corning Incorporated
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Araki, Nobuyasu	Yazaki Corporation
Aronson, Joseph	Texas Instruments Inc.
Baggett, Tim	Microchip Technology, Inc.
Beaudoin, Denis	Texas Instruments Inc.
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Bordogna, Mark	Intel Corporation
Boyer, Rich	Aptiv Signal and Power Solutions
Brandt, David	Rockwell Automation
Brillhart, Theodore	Fluke Corporation
Brooks, Paul	Viavi Solutions
Brown, Matthew	Huawei Technologies Canada
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Calvin, John	Keysight Technologies
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Castro, Jose	Panduit Corp.
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